

**WHAT IS CLAIMED IS:**

1. An information processing device comprising:

a housing comprising a metal heat conductor and a plurality of passages;

5 a processor disposed in said housing in thermal communication with said heat conductor, wherein said processor generates heat when energized, and wherein said heat conductor dissipates heat generated by said processor to an area external of said housing through said passages;

a circuit board arranged in said housing and comprising a mounting area, wherein said processor is mounted at said mounting area;

10 a pusher pushing said processor in a direction toward said heat conductor; and

wherein said pusher is disposed between said processor and said housing.

2. The information processing device of claim 1 wherein said circuit board is a printed circuit board.

15 3. The information processing device of claim 1 wherein said device is used for printing.